IEEE ICASSP 2017 will include a M.Sc./Ph.D. Forum. The forum will provide an opportunity for M.Sc./Ph.D. students in the fields of electronics, circuits, and embedded systems to present their thesis/dissertation research (completed in the last year), including work in progress within the topics of interest for ICASSP 2017. To encourage interaction among the M.Sc./Ph.D. students and researchers from academia, industry, and government, the forum will be organized as a poster session. A two-page paper on the thesis work will appear in the conference proceedings.

Current M.Sc./Ph.D. students, as well as researchers who had their M.Sc./Ph.D. dissertations in the last year (that are completed in the last year or will be completed during 2017), are encouraged to submit two-page papers. The submitted paper should clearly state:

- The original key idea / hypothesis of the thesis
- The problem domain and the specific problem addressed
- An overview of related work in the area of the Ph.D. work
- Methodological approach
- Research that has been carried out
- The expected or achieved contributions

Since this is expected to be a work conducted by the M.Sc./Ph.D. students, we request that the sole author is a M.Sc./Ph.D. student who is mainly responsible for conducting the research on the respective topic. In addition, the name of the advisor should appear, preceded by “Advisor:”

The main objective of the M.Sc./Ph.D. Forum is to offer an opportunity to the M.Sc./Ph.D. students to receive high-quality feedback from external reviewers and to directly interact with peers, exchange ideas, discuss concepts, and establish (in) formal cooperation with various research groups.

**Important Deadlines**

- M.Sc./Ph.D. submission proposals due: November 8th, 2016
- Notification of acceptance of proposals: November 30th, 2016

**Submission**

Proposals and inquiries should be sent via e-mail in PDF to the M.Sc./Ph.D. Forum chairs:

Ahmed Abdelgawad, Patrice Abry and Mayssaa Al Najjar

( msc-phd.forum@ieee-icassp2017.org )

By the November 8th, 2016 deadline.